

## **LPKF wins large order with new laser cutting systems**

*Garbsen/Hannover, 3 June 2010* – In addition to the successful development in the Laser Direct Structuring (LDS) business, LPKF is about to achieve another breakthrough. The company has received a major order for laser systems used for the depaneling of assembled PCBs. The order volume is just under EUR 6 million and will generate turnover in the Cutting and Structuring Lasers segment within the current financial year.

The newly developed LPKF MicroLine laser system will finally make the depaneling by laser in mass production competitive and delivers at the same time unmatched accuracy.

Further details are being kept confidential in agreement with the client.

LPKF Laser & Electronics AG shares are listed in the Prime Standard of the Frankfurt Stock Exchange (ISIN 0006450000).